U.S. Appl. No. 10/552548

DO/EO WORKSHI

International Appl. No. FR2004/050/51

-	Application filed by: 🔲 20 months 🗀 30 months	
	WIPO PUBLICATION INFORMATION:	
Publication No.: WO2041093202 M Publication Language: O Buglish O Japanese		Screening Done by:
Pu	ibilication Date: Oct 28, 2004  Not Published: Que. octy designated Q BP request	SLA
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团	Priority Document (s) No. 1	<u> </u>
RECEIPTS FROM THE APPLICANT (other than checked above):		
<b>(2</b> )	Basic National Fee (or authorization to charge) Preliminary Amendment(s) Filed o	ti :
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	Words in the Drawing Figure(s) - (# of dwgs. 5) D Power of Attorney/ Change of Add	
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	Annexes to 409 Qualif Declaration (executed)	
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NOTES: U L.A. used as Specification U Other:		
35 U.S.C	C. 371 - Receipt of Request (PTO-1390) · Oct 12 200-5	
Date Ac	ceptable Oath/Declaration Received	
Date of	Campletion of requirements under 35 U.S.C. 371	
102(e) Date		
Date of Completion of DO/ BO 903 - Notification of Acceptance		
Date of Completion of DO/ BO 905 - Notification of Missing Requirements Sept 29, LWE		
Date of Completion of DU/ EO 906 - Notification of Missing 102(c) Requirements		
Date of Completion of DO/EO 907 - Notification of Acceptance for 102(e) Date		
Date of Completion of DO/ BO 909 - Notification of Abandonment		
Date of Completion of DO/ BO 911 - Application Accepted Under 35 U.S.C. 111		
Date of Completion of DO/ BO 916 - Notification of Defective Response		
Date of Completion of DOI EO 910 - Natification to Comply of Seq. Requirements		